 Inputs Are TTL-Voltage Compatible Speed of Bipolar F, AS, and S, With Significantly Reduced Power Consumption 	CD54ACT05 F PACKAGE CD74ACT05 E OR M PACKAGE (TOP VIEW)
 Balanced Propagation Delays 	1A [] 1 14] V _{CC}
 ±24-mA Output Drive Current Fanout to 15 F Devices 	1Y [2 13] 6A 2A [3 12] 6Y
 SCR-Latchup-Resistant CMOS Process and Circuit Design 	2Y 4 11 5A 3A 5 10 5Y
 Exceeds 2-kV ESD Protection Per MIL-STD-883, Method 3015 	3Y 6 9 4A GND 7 8 4Y

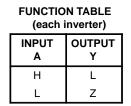
description

The 'ACT05 devices contain six independent inverters. These devices perform the Boolean function $Y = \overline{A}$. The open-drain outputs require pullup resistors to perform correctly, and can be connected to other open-drain outputs to implement active-low wired-OR or active-high wired-AND functions.

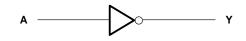
TA	PACKAGE		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – E	Tube	CD74ACT05E	CD74ACT05E
–55°C to 125°C	SOIC – M	Tube	CD74ACT05M	ACT05M
-55°C to 125°C	25°C 50IC - M	Tape and reel	CD74ACT05M96	ACTOSIM
	CDIP – F	Tube	CD54ACT05F3A	CD54ACT05F3A

ORDERING INFORMATION

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



logic diagram, each inverter (positive logic)





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CD54ACT05, CD74ACT05 HEX INVERTERS WITH OPEN-DRAIN OUTPUTS

SCHS311B – JANUARY 2001 – REVISED JUNE 2002

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC}	–0.5 V to 6 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1)	
Output clamp current, I_{OK} (V _O < 0 or V _O > V _{CC}) (see Note 1)	
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	±50 mA
Continuous current through V _{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 2): E package	80°C/W
M package	
Storage temperature range, T _{stg}	−65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

		T _A = 2	25°C	–40°C TO 85°C		–55°C TO 125°C		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
VCC	Supply voltage	4.5	5.5	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2		2		2		V
VIL	Low-level input voltage		0.8		0.8		0.8	V
VI	Input voltage	0	VCC	0	VCC	0	VCC	V
Vo	Output voltage	0	5.5	0	5.5	0	5.5	V
ЮН	High-level output current		-24		-24		-24	mA
IOL	Low-level output current		24		24		24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate		10		10		10	ns/V

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	Vcc	T _A = 25°C		–40°C TO 85°C		–55°C TO 125°C		UNIT			
						MIN	MAX	MIN	MAX	MIN	MAX	
		I _{OL} = 50 μA	4.5 V		0.1		0.1		0.1			
V_{OL} $V_{I} = V_{IH} \text{ or } V_{IL}$	I _{OL} = 24 mA	4.5 V		0.36		0.44		0.5	v			
		I _{OL} = 50 mA‡	5.5 V						1.65	v		
		I _{OL} = 75 mA‡	5.5 V				1.65					
li	$V_I = V_{CC} \text{ or } GND$		5.5 V		±0.1		±1		±1	μA		
ICC	$V_I = V_{CC}$ or GND,	IO = 0	5.5 V		4		40		80	μA		
∆ICC	$V_{I} = V_{CC} - 2.1 V$		4.5 V to 5.5 V		2.4		2.8		3	mA		
Ci					10		10		10	pF		

[‡] Test one output at a time, not exceeding 1-second duration. Measurement is made by forcing indicated current and measuring voltage to minimize power dissipation. Test verifies a minimum 50-Ω transmission-line drive capability at 85°C and 75-Ω transmission-line drive capability at 125°C.



ACT INPUT LOAD TABLE

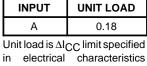


table (e.g., 2.4 mA at 25°C).

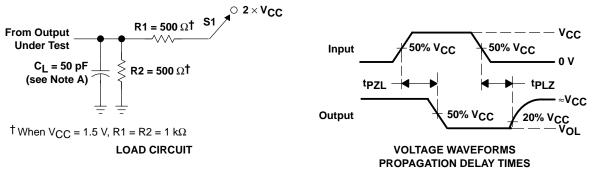
switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)				–55°C 125	UNIT	
		(001-01)	MIN	MAX	MIN	MAX	
^t PZL	A or B	v	2.4	8.5	2.3	9.3	ns
^t PLZ			2.8	9.8	2.7	10.8	115

operating characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

	PARAMETER	TYP	UNIT
Cpd	Power dissipation capacitance	105	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f \leq 3 ns, t_f \leq 3 ns.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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